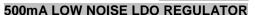
© Diodes Incorporated





Description

The AP2213 is a 500mA output current fixed voltage regulator which provides low noise, very low dropout voltage (typically 350mV at 500mA), very low standby current (1µA maximum), and excellent power supply ripple rejection (PSRR 75dB at 100Hz). This device is used in battery-powered applications, such as handsets and PDAs; and in noise sensitive applications, such as RF electronics.

The AP2213 features individual logic compatible enable/shutdown control inputs, a low power shutdown mode for extended battery life, over-current protection, over-temperature protection, and reversed current protection.

The AP2213 has 2.5V, 3.0V, and 3.3V versions.

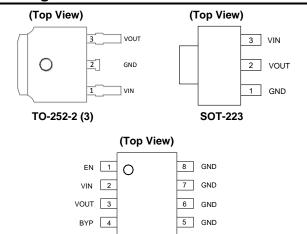
The AP2213 is available in the TO-252-2 (3), SOIC-8, and SOT-223 packages.

Features

- Up to 500mA Output Current
- Low Standby Current
- Low Dropout Voltage: V_{DROP} = 350mV at 500mA
- High Output Accuracy: ±1%
- Good Ripple Rejection Ability: 75dB at 100Hz and I_{OUT} = 100µA
- Tight Load and Line Regulation
- Low Temperature Coefficient
- Over Current Protection
- Thermal Protection
- **Reversed Current Protection**
- Logic-Controlled Enable
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish-Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight:
 - TO252-2 (3): 0.312 grams (Approximate)
 - SOT-223: 0.116 grams (Approximate)
 - SOIC-8: 0.077 grams (Approximate)
- Lead-Free Packages: TO-252-2 (3), SOT-223, SOIC-8
 - Totally Lead-Free; RoHS Compliant (Notes 1 & 2)
- Lead-Free Packages, Available in "Green" Molding Compound: TO-252-2 (3), SOT-223, SOIC-8
 - Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
 - Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Pin Assignments



SOIC-8

Applications

- Laptop, Notebook, and Palmtop Computer
- CD-ROM, CD-R/RW, DVD Driver
- Portable Electronic
- PC Peripheral

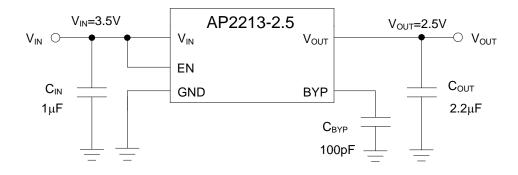
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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Typical Applications Circuit (Note 4)



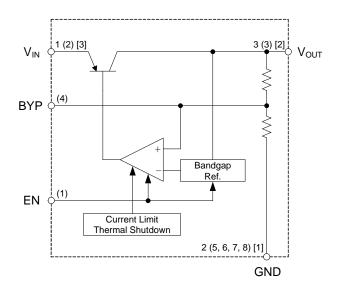
Notes:

4. Dropout voltage is 350mV when T_A = +25°C. In order to obtain a normal output voltage, V_{OUT}+0.35V is the minimum input voltage which will result in a low PSRR, imposing a bad influence on system. Therefore, the recommended input voltage is V_{OUT}+1V to 18V. For AP2213-2.5 version, its input voltage can be set from 3.5V(V_{OUT}+1V) to 18V.

Pin Descriptions

	Pin Number		Dia Nama	Funding
TO-252-2 (3)	SOIC-8	SOT-223	Pin Name	Function
3	3	2	VOUT	Regulated output voltage
2	5, 6, 7, 8	1	GND	Ground
1	2	3	VIN	Input Voltage
_	1	_	EN	Enable input: CMOS or TTL compatible input. Logic high = enable, logic low = shutdown
_	4		BYP	Bypass capacitor for low noise operation

Functional Block Diagram



A (B) [C] A for TO-252-2 (3) B for SOIC-8 C for SOT-223



Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Ra	Rating	
V_{IN}	Supply Input Voltage	2	20	V
V_{EN}	Enable Input Voltage	2	20	V
P _D	Power Dissipation	Internally Limited (Thermal Protection)	W
T _{LEAD}	Lead Temperature (Soldering, 10s)	+2	260	°C
TJ	Junction Temperature	+1	+150	
T _{STG}	Storage Temperature	-65 to	-65 to +150	
	ESD (Machine Model)	3	00	
ESD	ESD (Human Body Model)	60	000	V
	ESD (Charge Device Model)	20	000	
		TO-252-2 (3)	90	
θ_{JA}	Thermal Resistance (No Heatsink)	SOIC-8	160	°C/W
		SOT-223	108]

Notes: 5. Stresses greater than those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods can affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{IN}	Supply Input Voltage	2.5	18	V
V _{EN}	Enable Input Voltage	0	18	V
TJ	Operating Junction Temperature	-40	+125	°C



AP2213-2.5 Electrical Characteristics (@V_{IN} = 3.5V, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{EN} \geq 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C \leq T_J \leq +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	0	V : :: (0 '' IV	-1	_	1	2.6
ΔV _{OUT} /V _{OUT}	Output Voltage Accuracy	Variation from Specified V _{OUT}	-2	_	2	%
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature		_	120	1	μV/°C
(ΔV _{OUT} /V _{OUT})/ΔΤ	Coefficient (Note 7)	_	_	48	1	ppm/°C
V	Line Degulation	V _{IN} = 3.5V to 13.2V		1.5	4.5	m)/
VRLINE	Line Regulation	VIN = 3.5V to 13.2V	_	_	12	mV
V _{RLOAD}	Load Regulation (Note 8)	I _{OUT} = 0.1mA to 500mA	_	1	7	mV
VRLOAD	Load Regulation (Note 6)	1001 = 0.1111A to 500111A	_	_	17	IIIV
		I _{OUT} = 100μA	_	15	50	
		1007 = 100μΑ	_	_	70	
		I _{OUT} = 50mA	_	110	150	
		1001 – 3011A	_	_	230	
		I _{OUT} = 100mA	_	140	250	mV
V	Dronout Voltage (Note 0)	1001 = 100111A	_	_	300	
V _{DROP}	Dropout Voltage (Note 9)	I _{OUT} = 150mA	_	165	275	
			_	_	350	
			_	250	400	
			_		500	
		5004		350	600	
		I _{OUT} = 500mA	_	_	700	
		V _{EN} ≤ 0.4V (Shutdown)	_	0.01	1	
I _{STD}	Standby Current	V _{EN} ≤ 0.18V (Shutdown)	_		5	μΑ
		100.4		100	150	
		V _{EN} ≥ 2.0V, I _{OUT} = 100μA	_		180]
		V > 2.0V I F0 = A	_	350	600	μΑ
		V _{EN} ≥ 2.0V, I _{OUT} = 50mA	_		800	
	Occurred Dia Occurrent (Nets 40)	V > 0.0V 450 mA		1.3	1.9	
I_{GND}	Ground Pin Current (Note 10)	V _{EN} ≥ 2.0V, I _{OUT} = 150mA	_	_	2.5	
		V >0.0VI 200::A	_	4	10	mA
		V _{EN} ≥ 2.0V, I _{OUT} = 300mA	_		15	
		V > 0.0V 500 A	_	11	20	
		V _{EN} ≥ 2.0V, I _{OUT} = 500mA	_	_	28	



AP2213-2.5 Electrical Characteristics (cont.) (@V_{IN} = 3.5V, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{EN} \geq 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C \leq T_J \leq +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
PSRR	Ripple Rejection	f = 100Hz, I _{OUT} = 100μA	_	75	_	dB	
I _{LIMIT}	Current Limit V _{OUT} = 0V		_	700	1000	mA	
e _{no}	Output Noise Iout = 50mA, Cout = 2.2µF, 100pF from BYP to GND		_	260	_	nV/\sqrt{Hz}	
.,			_	_	0.4	.,	
V _{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	_	_	0.18	V	
V _{IH}	Enable Input Logic-High Voltage	Regulator Enabled	2.0	_	_	V	
		V _{IL} ≤ 0.4V	_	0.01	1		
I _{IL}	Enable Input Logic-Low Current	V _{IL} ≤ 0.18V	_	_	2	μA	
		V _{IH} ≥ 2.0V	_	5	20		
I _{IH}	Enable Input Logic-High Current	Enable Input Logic-High Current V _{IH} ≥ 2.0V		_	25	μΑ	
		TO-252-2 (3)	_	20	_		
θЈС	Thermal Resistance	SOIC-8	_	45	_	°C/W	
		SOT-223	_	31	_		

Notes:

- 6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
- 7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- 8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- 9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
- 10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.



AP2213-3.0 Electrical Characteristics (@V_{IN} = 4V, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{EN} \geq 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C \leq T_J \leq +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		V	-1	_	1	2,4
$\Delta V_{OUT}/V_{OUT}$	Output Voltage Accuracy	Variation from Specified V _{OUT}	-2	_	2	%
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature		_	120	1	μV/°C
(ΔV _{OUT} /V _{OUT})/ΔΤ	Coefficient (Note 7)	_	_	40		ppm/°C
V	Line Degulation	\/ 4\/.to 42.0\/	_	1.5	4.5	\/
V _{RLINE}	Line Regulation	V _{IN} = 4V to 13.2V	_	_	12	mV
\/	Load Regulation (Note 9)	la 0.4m Λ to Ε00m Λ	_	1	8	mV
V _{RLOAD}	Load Regulation (Note 8)	I _{OUT} = 0.1mA to 500mA	_	_	17	mv
		I _{OUT} = 100μA	_	15	50	
		100Τ = 100μΑ	_	_	70	
	V _{DROP} Dropout Voltage (Note 9)	J	_	110	150	
		I _{OUT} = 50mA	_	_	230	
		I _{OUT} = 100mA	_	140	250	m∨
V			_	_	300	
V DROP		I _{OUT} = 150mA	_	165	275	
			_	_	350	
			_	250	400	
			_	_	500	
			_	350	600	
		I _{OUT} = 500mA	_	_	700	
	Chan allow Course at	V _{EN} ≤ 0.4V (Shutdown)	_	0.01	1	
I _{STD}	Standby Current	V _{EN} ≤ 0.18V (Shutdown)	_	_	5	μΑ
		V >2.0V I 400··A	_	100	150	
		V _{EN} ≥ 2.0V, I _{OUT} = 100μA	_	_	180	
		V _{EN} ≥ 2.0V, I _{OUT} = 50mA	_	350	600	μΑ
		VEN 2 2.0V, IOUT = SUITIA	_	_	800	
	Cround Din Current (Note 10)	\\ > 2.0\\ I 450m A	_	1.3	1.9	
I _{GND}	Ground Pin Current (Note 10)	V _{EN} ≥ 2.0V, I _{OUT} = 150mA	_	_	2.5	
		\/> 2 0\/ love = 200m \/	_	4	10	mA
		V _{EN} ≥ 2.0V, I _{OUT} = 300mA	_	_	15	
		V >0.0V I = 500A	_	11	20	
		V _{EN} ≥ 2.0V, I _{OUT} = 500mA	_	_	28	



AP2213-3.0 Electrical Characteristics (cont.) (@V_{IN} = 4V, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{EN} \geq 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C \leq T_J \leq +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
PSRR	Ripple Rejection	f = 100Hz, I _{OUT} = 100μA	_	75	_	dB	
I _{LIMIT}	Current Limit	Current Limit V _{OUT} = 0V		700	1000	mA	
e _{no}	Output Noise		_	260	_	nV/\sqrt{Hz}	
.,		D 14 01 41	_	_	0.4	.,	
V _{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	_	_	0.18	V	
V _{IH}	Enable Input Logic-High Voltage	Enable Input Logic-High Voltage Regulator Enabled 2.0		_	_	V	
		V _{IL} ≤ 0.4V	_	0.01	1		
I _{IL}	Enable Input Logic-Low Current	V _{IL} ≤ 0.18V	_	_	2	μA	
		V _{IH} ≥ 2.0V	_	5	20	_	
I _{IH}	Enable Input Logic-High Current	nable Input Logic-High Current V _{IH} ≥ 2.0V		_	25	μΑ	
		TO-252-2 (3)	_	20	_		
θЈС	Thermal Resistance	SOIC-8	_	45	_	°C/W	
		SOT-223	_	31	_		

Notes:

- 6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
- 7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- 8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- 9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
- 10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.



AP2213-3.3 Electrical Characteristics (@V_{IN} = 4.3V, I_{OUT} = 100 μ A, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{EN} \geq 2.0V, T_J = +25°C, **Bold** typeface applies over -40°C \leq T_J \leq +125°C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	0	V : :: (0 '' IV	-1	_	1	2,
$\Delta V_{OUT}/V_{OUT}$	Output Voltage Accuracy	Variation from Specified V _{OUT}	-2	_	2	%
$\Delta V_{OUT}/\Delta T$	Output Voltage Temperature		_	120	_	μV/°C
(ΔV _{OUT} /V _{OUT})/ΔΤ	Coefficient (Note 7)	_	_	36.3	_	ppm/°C
V	Line Demulation	V _{IN} = 4.3V to 13.2V		1.5	4.5	>/
V _{RLINE}	Line Regulation	VIN = 4.3V to 13.2V	_	_	12	mV
.,	Load Danislation (Note 0)	0.4 0.4 500 0.	_	1	9	>/
V _{RLOAD}	Load Regulation (Note 8)	I _{OUT} = 0.1mA to 500mA	_	_	18	mV
		1 400	_	15	50	
		I _{OUT} = 100μA	_	_	70	
		I 50m A	_	110	150	
		I _{OUT} = 50mA	_	_	230	
		100-0	_	140	250	mV
V	Dranavit Valtaria (Nata O)	I _{OUT} = 100mA	_	_	300	
V _{DROP}	Dropout Voltage (Note 9)	I _{OUT} = 150mA	_	165	275	
			_	_	350	
			_	250	400	
			_	_	500	
		, 500m A	_	350	600	
		I _{OUT} = 500mA	_	_	700	
	Olandika Olamad	V _{EN} ≤ 0.4V (Shutdown)	_	0.01	1	
I _{STD}	Standby Current	V _{EN} ≤ 0.18V (Shutdown)		_	5	μΑ
		100.4		100	150	
		V _{EN} ≥ 2.0V, I _{OUT} = 100μA	_	_	180	1
		V > 2.0V I F0 = A	_	350	600	μΑ
		V _{EN} ≥ 2.0V, I _{OUT} = 50mA	_	_	800	
	Occurred Dia Occurrent (Nets 40)	V > 0.0V 450 mA		1.3	1.9	
IGND	Ground Pin Current (Note 10)	V _{EN} ≥ 2.0V, I _{OUT} = 150mA	_	_	2.5	mA
		\\\> 2 0\\ \ \ 200~ \\	_	4	10	
		V _{EN} ≥ 2.0V, I _{OUT} = 300mA	_	_	15	
		V> 2 0\/ l	_	11	20	
		V _{EN} ≥ 2.0V, I _{OUT} = 500mA		_	28	



AP2213-3.3 Electrical Characteristics (cont.) (@ $V_{IN} = 4.3V$, $I_{OUT} = 100\mu$ A, $C_{IN} = 1.0\mu$ F, $C_{OUT} = 2.2\mu$ F, $V_{EN} \ge 2.0V$, $T_{J} = +25^{\circ}$ C, **Bold** typeface applies over -40°C $\le T_{J} \le +125^{\circ}$ C (Note 6), unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
PSRR	Ripple Rejection	f = 100Hz, I _{OUT} = 100μA	_	75	_	dB	
I _{LIMIT}	Current Limit V _{OUT} = 0V		_	700	1000	mA	
e _{no}	Output Noise Iout = 50mA, Cout = 2.2µF, 100pF from BYP to GND		_	260	_	nV/\sqrt{Hz}	
.,			_	_	0.4	.,	
V _{IL}	Enable Input Logic-Low Voltage	Regulator Shutdown	_	_	0.18	V	
V _{IH}	Enable Input Logic-High Voltage	Regulator Enabled	2.0	_	_	V	
		V _{IL} ≤ 0.4V	_	0.01	1		
I _{IL}	Enable Input Logic-Low Current	V _{IL} ≤ 0.18V	_	_	2	μA	
		V _{IH} ≥ 2.0V	_	5	20		
I _{IH}	Enable Input Logic-High Current	Enable Input Logic-High Current V _{IH} ≥ 2.0V		_	25	μΑ	
		TO-252-2 (3)	_	20	_		
θЈС	Thermal Resistance	SOIC-8	_	45	_	°C/W	
		SOT-223	_	31	_		

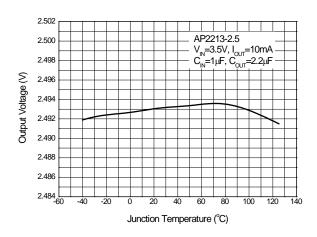
Notes:

- 6. Specifications in bold type are limited to -40°C ≤ T_J ≤ +125°C. Limits over temperature are guaranteed by design, but not tested in production.
- 7. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- 8. Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 500mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- 9. Dropout voltage is defined as the input to output differential at which the output voltage drops 1% (T_J = +25°C) or 2% (-40°C ≤ T_J ≤ +125°C) below its nominal value measured at 1V differential.
- 10. Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.

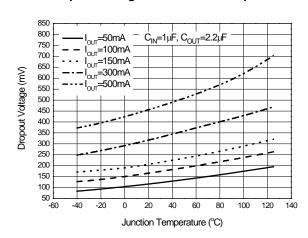


Performance Characteristics

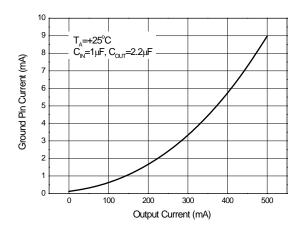
Output Voltage vs. Junction Temperature



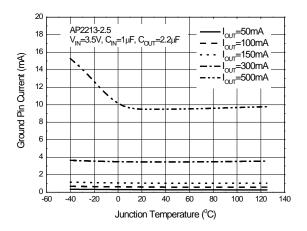
Dropout Voltage vs. Junction Temperature



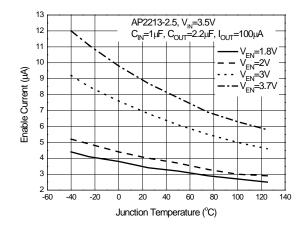
Ground Pin Current vs. Output Current



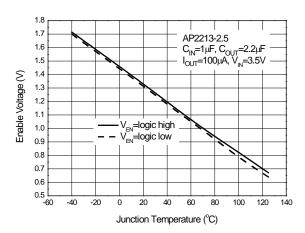
Ground Pin Current vs. Junction Temperature



Enable Current vs. Junction Temperature



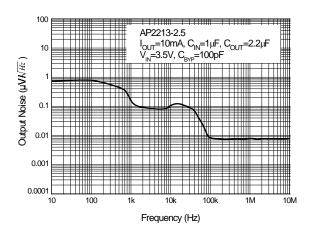
Enable Voltage vs. Junction Temperature



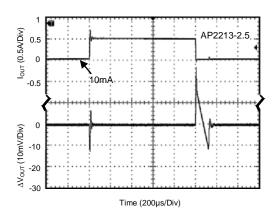


Performance Characteristics (cont.)

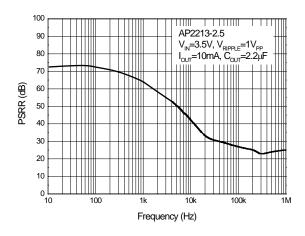
Output Noise vs. Frequency

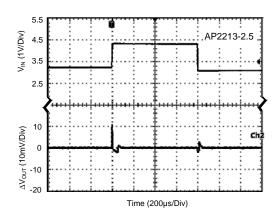


 $\label{eq:load_transient} Load\ Transient \\ (Conditions: V_{IN}=3.5V,\ C_{BYP}=100pF,\ V_{EN}=2V, \\ I_{OUT}=10mA\ to\ 500mA,\ C_{IN}=1.0\mu F,\ C_{OUT}=2.2\mu F) \\ \end{array}$

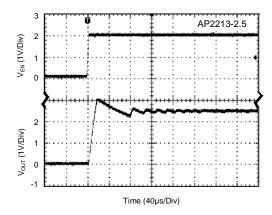


PSRR vs. Frequency

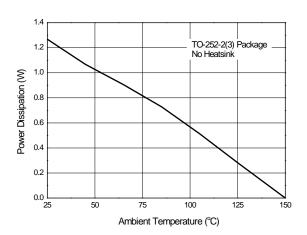




 $V_{EN}~vs.~V_{OUT}$ (Conditions: $V_{EN}=0V$ to 2V, $V_{IN}=3.5V$, $I_{OUT}=30mA$, $C_{BYP}=open,~C_{IN}=1.0\mu F,~C_{OUT}=2.2\mu F)$



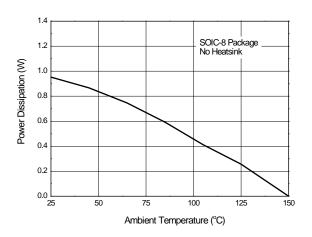
Power Dissipation vs. Ambient Temperature



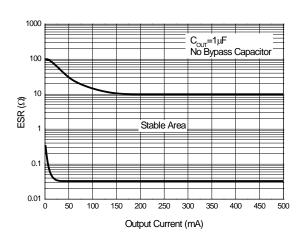


Performance Characteristics (cont.)

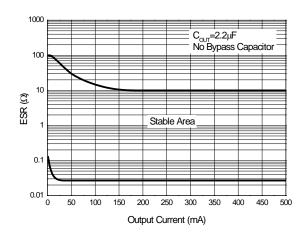
Power Dissipation vs. Ambient Temperature



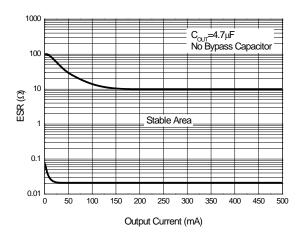
ESR vs. Output Current



ESR vs. Output Current



ESR vs. Output Current





Application Information

Input Capacitor

A 1µF minimum capacitor is recommended to be placed between V_{IN} and GND.

Output Capacitor

An output capacitor is required to prevent oscillation. A $1\mu F$ minimum is recommended when C_{BYP} is unused. A $2.2\mu F$ minimum is recommended when C_{BYP} is 100pF. The output capacitor may be increased to improve transient response.

Noise Bypass Capacitor

A bypass capacitor is connected to the internal voltage reference. A small capacitor connected from BYP to GND makes this reference quiet, resulting in a significant reduction in output noise, but the ESR stable area will be narrowed. In order to keep the output stability, it is recommended to use the bypass capacitor no more than 100pF.

The start-up speed of the AP2213 is inversely proportional to the value of the reference bypass capacitor. In some cases, if output noise is not a major concern and rapid turn-on is necessary, omit C_{BYP} and leave BYP open.

Power Dissipation

Thermal shutdown may take place if the maximum power dissipation is exceeded in application. Under all possible operating conditions, the junction temperature must be within the range specified under absolute maximum ratings to avoid thermal shutdown.

To determine if the power dissipated in the regulator reaches the maximum power dissipation (see Figure Power Dissipation vs. Ambient Temperature (SOIC-8 Package), ESR vs. Output Current ($C_{OUT} = 1\mu F$)), use:

 $T_J = P_D^*\theta_{JA} + T_A$

 $P_D = (V_{IN}-V_{OUT})*I_{OUT}+V_{IN}*I_{GND}$

Where: $T_J \le T_{J(max)}$, $T_{J(max)}$ is absolute maximum ratings for the junction temperature; $V_{IN}^*I_{GND}$ can be ignored due to its small value.

 $T_{J(\text{max})}$ is +150°C, θ_{JA} is 90°C/W for TO-252-2 (3) package and 160°C/W for SOIC-8 package.

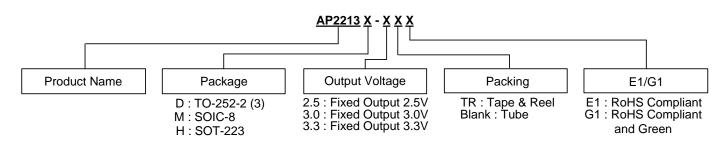
Example: For 2.5V version packaged in SOIC-8, I_{OUT} = 500mA, T_A = +50°C, V_{IN(Max)} is:

(150°C-50°C)/(0.5A*160°C/W)+2.5V=3.75V

Therefore, for good performance, please make sure that the input voltage is less than 3.75V without heatsink when $T_A = +50^{\circ}C$.



Ordering Information



			Part N	lumber	Mark	ing ID	
	Package	Temperature Range	RoHS Compliant	RoHS Compliant and Green	RoHS Compliant	RoHS Compliant and Green	Packing
			AP2213D-2.5E1	AP2213D-2.5G1	AP2213D- 2.5E1	AP2213D- 2.5G1	100/Tube
	Lead-Free TO-252-2 (3)		AP2213D-2.5TRE1	AP2213D-2.5TRG1	AP2213D- 2.5E1	AP2213D- 2.5G1	2500/Tape & Reel
Lead-Free			AP2213D-3.0E1	AP2213D-3.0G1	AP2213D- 3.0E1	AP2213D- 3.0G1	100/Tube
Pb		-40 to +125°C	AP2213D-3.0TRE1	AP2213D-3.0TRG1	AP2213D- 3.0E1	AP2213D- 3.0G1	2500/Tape & Reel
Lead-Free Green				AP2213D-3.3E1	AP2213D-3.3G1	AP2213D- 3.3E1	AP2213D- 3.3G1
				AP2213D-3.3TRE1	AP2213D-3.3TRG1	AP2213D- 3.3E1	AP2213D- 3.3G1
			AP2213M-2.5E1	AP2213M-2.5G1	2213M-2.5E1	2213M-2.5G1	100/Tube
(N)			AP2213M-2.5TRE1	AP2213M-2.5TRG1	2213M-2.5E1	2213M-2.5G1	2500/Tape & Reel
Lead-Free			AP2213M-3.0E1	AP2213M-3.0G1	2213M-3.0E1	2213M-3.0G1	100/Tube
Pb	SOIC-8	-40 to +125°C	AP2213M-3.0TRE1	AP2213M-3.0TRG1	2213M-3.0E1	2213M-3.0G1	2500/Tape & Reel
Lead-Free Green			AP2213M-3.3E1	AP2213M-3.3G1	2213M-3.3E1	2213M-3.3G1	100/Tube
			AP2213M-3.3TRE1	AP2213M-3.3TRG1	2213M-3.3E1	2213M-3.3G1	2500/Tape & Reel
(Pub)	ad-Free SOT-223		AP2213H-2.5TRE1	AP2213H-2.5TRG1	EH13C	GH13C	4000/Tape & Reel
Lead-Free		SOT-223 -40 to +125°C	AP2213H-3.0TRE1	AP2213H-3.0TRG1	EH13E	GH13E	4000/Tape & Reel
Lead-Free Green			AP2213H-3.3TRE1	AP2213H-3.3TRG1	EH13F	GH13F	4000/Tape & Reel



Marking Information

(1) TO-252-2 (3)

(Top View)

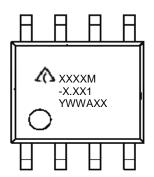


First and Second Lines: Logo and Marking ID (See Ordering Information) Third Line: Date Code Y: Year WW: Work Week of Molding

A: Assembly House Code XX: 7th and 8th Digits of Batch Number

(2) SOIC-8

(Top View)



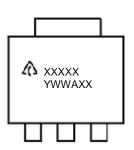
First and Second Lines: Logo and Marking ID (See Ordering Information)
Third line: Date Code Y: Year

WW: Work Week of Molding

A: Assembly House Code XX: 7th and 8th Digits of Batch Number

(3) SOT-223

(Top View)

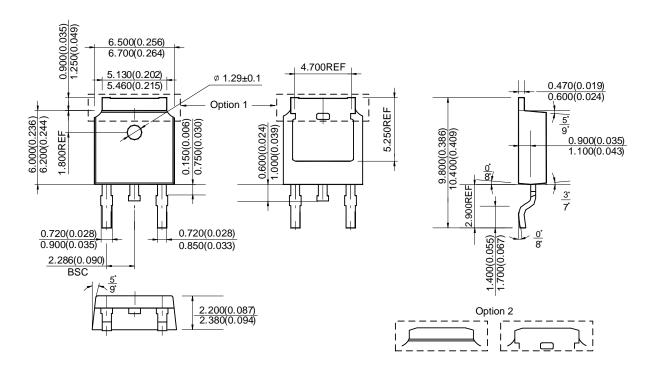


First Line: Logo and Marking ID (See Ordering Information) Second Line: Date Code Y: Year WW: Work Week of Molding A: Assembly House Code XX: 7th and 8th Digits of Batch Number



Package Outline Dimensions (All dimensions in mm(inch).)

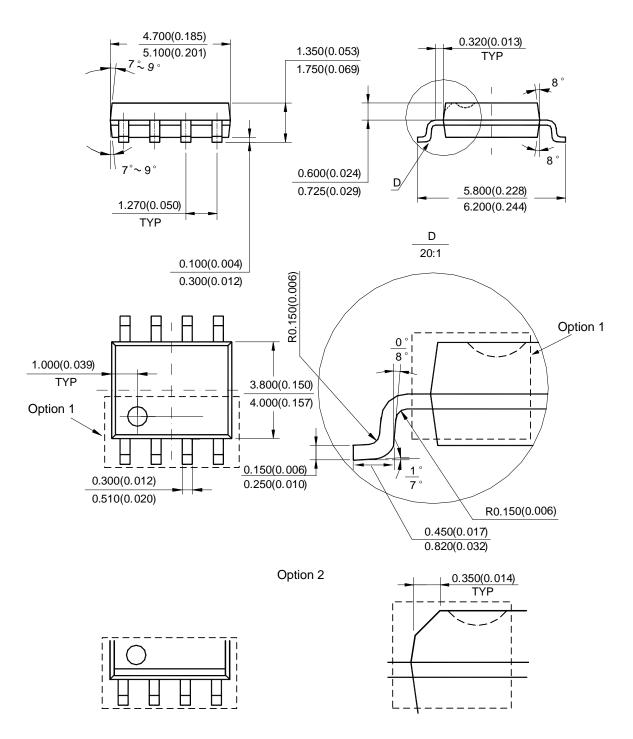
(1) Package Type: TO-252-2 (3)





Package Outline Dimensions (All dimensions in mm(inch).) (continued)

(2) Package Type: SOIC-8

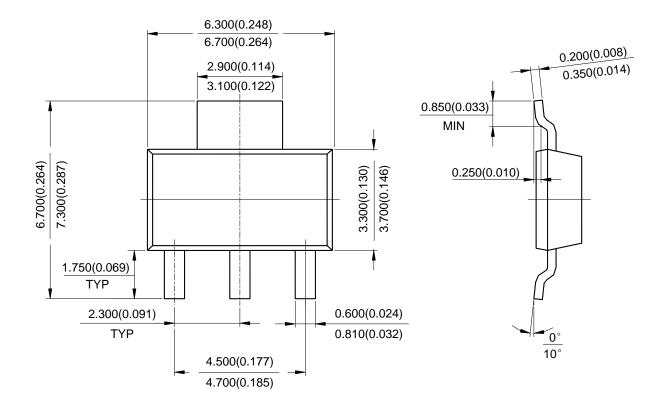


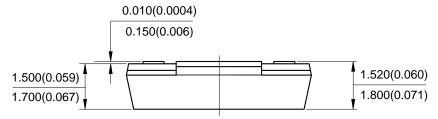
Note: Eject hole, oriented hole and mold mark is optional.



Package Outline Dimensions (All dimensions in mm(inch).) (continued)

(3) Package Type: SOT-223

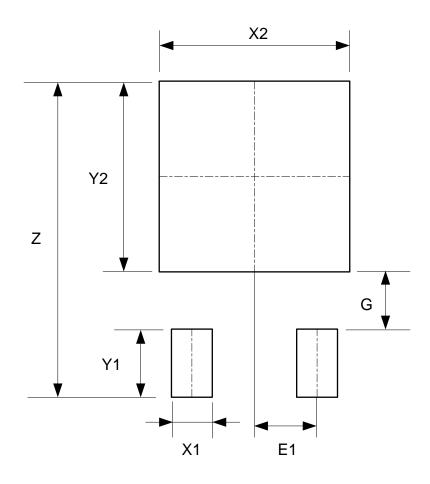






Suggested Pad Layout

(1) Package Type: TO-252-2 (3)

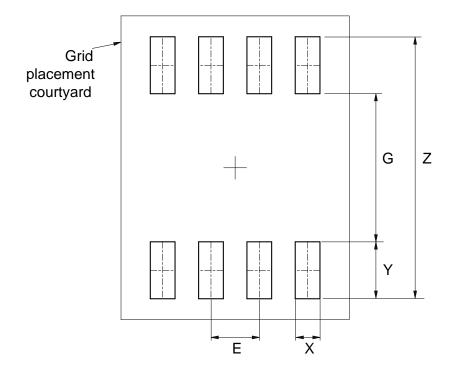


Dimensions	Z	X1	X2=Y2	Y1	G	E1
Difficitions	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	11.600/0.457	1.500/0.059	7.000/0.276	2.500/0.098	2.100/0.083	2.300/0.091



Suggested Pad Layout (continued)

(2) Package Type: SOIC-8

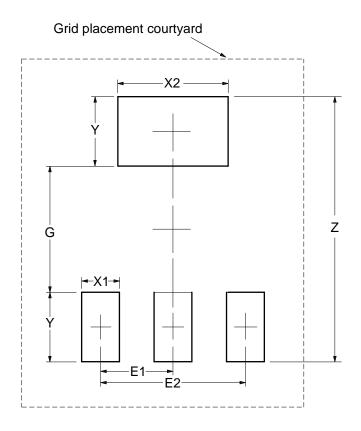


Dimensions	Z	G	Х	Υ	E
Diffictions	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050



Suggested Pad Layout (continued)

(3) Package Type: SOT-223



Dimensions	Z	G	X1	X2	Υ	E1	E2
	(mm)/(inch)						
Value	8.400/0.331	4.000/0.157	1.200/0.047	3.500/0.138	2.200/0.087	2.300/0.091	4.600/0.181



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